

WP42WUM/EGW

3mm Single-Level Circuit Board Indicator



DESCRIPTIONS

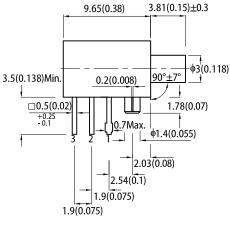
- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode
- The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode

FEATURES

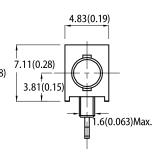
- · Pre-trimmed leads for pc mounting
- Black case enhances contrast ratio
- · High reliability-life measured in years
- Housing UL rating: 94V-0
- Housing material: Type 66 nylon
- RoHS compliant

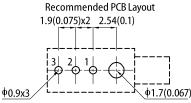
APPLICATIONS

- · Status indicator
- Illuminator
- Signage applications
- · Decorative and entertainment lighting
- · Commercial and residential architectural lighting



PACKAGE DIMENSIONS







1 Anode Red 2 Common Cathode 3 Anode Green

Notes

All dimensions are in millimeters (inches).
 Tolerance is ±0.25(0.01") unless otherwise noted.

 Lead spacing is measured where the leads emerge from the package.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]	
			Min.	Тур.	201/2	
WP42WUM/EGW	 High Efficiency Red (GaAsP/GaP) 	White Diffused	10	20		
			*4	*8	140°	
	Green (GaP)		4	12		
			*4	*12		

Notes

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
 * Luminous intensity value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Parameter		Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	High Efficiency Red Green	627 565		nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	High Efficiency Red Green	617 568		nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	High Efficiency Red Green	45 30		nm
Capacitance	С	High Efficiency Red Green	15 15		pF
Forward Voltage $I_F = 20 \text{mA}$	V _F ^[2]	High Efficiency Red Green	2.0 2.2	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	High Efficiency Red Green	-	10 10	uA

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

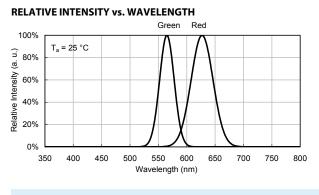
D	Symbol	Valu	1114		
Parameter		High Efficiency Red	Green	– Unit	
Power Dissipation	P _D	75 62.5		mW	
Reverse Voltage	V _R	5 5		V	
Junction Temperature	Tj	125 110		°C	
Operating Temperature	T _{op}	-40 to +85		°C	
Storage Temperature	T _{stg}	-40 to +85		°C	
DC Forward Current	I _F	30 25		mA	
Peak Forward Current	I _{FM} ^[1]	160	140	mA	
Electrostatic Discharge Threshold (HBM)	-	8000	8000	V	
Lead Solder Temperature ^[2]		260°C For 3 Seconds			
Lead Solder Temperature ^[3]		260°C For 5 Seconds			

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. 2mm below package base. 3. 5mm below package base. 4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

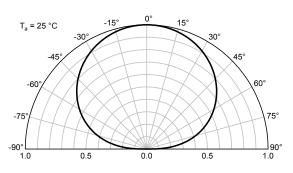
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TECHNICAL DATA

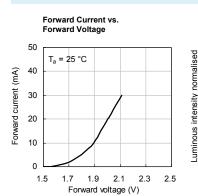


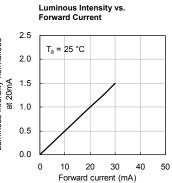
SPATIAL DISTRIBUTION



HIGH EFFICIENCY RED

GREEN

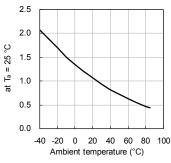




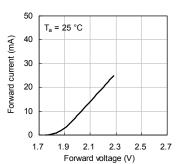
50 Permissible forward current (mA) Luminous intensity normalised at Ta = 25 $^\circ\mathrm{C}$ 40 30 20 10 0 -40 -20 0 20 40 60 80 100 Ambient temperature (°C)

Forward Current Derating Curve

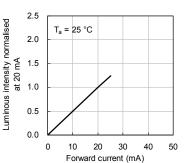
Luminous Intensity vs. Ambient Temperature



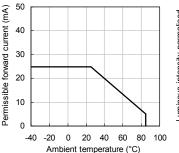
Forward Current vs. Forward Voltage



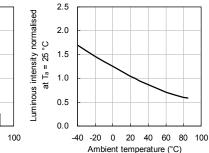
Luminous Intensity vs. Forward Current



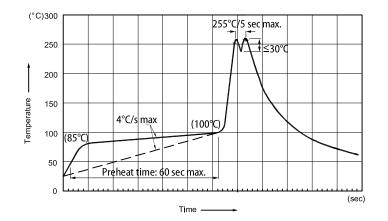
Forward Current Derating Curve



Luminous Intensity vs. Ambient Temperature



RECOMMENDED WAVE SOLDERING PROFILE



Notes:

- 1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C

Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
 Do not apply stress to the epoxy resin while the temperature is above 85°C.
 Fixtures should not incur stress on the component when mounting and during soldering process.

5. SAC 305 solder alloy is recommended.
 6. No more than one wave soldering pass